IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

) Confirmation No.: 9242
) Group Art Unit: 2841
Applicants: VANDENTOP et al.	Examiner: Dinh, Tuan T.
Application Serial No.: 10/667,694) TRANSMITTAL LETTER
Filing Date: September 22, 2003) Docket No.: P16922
For: INTEGRATED CIRCUIT DIE/PACKAGE INTERCONNECT	 PTO Customer Number 28062 Buckley, Maschoff & Talwalkar LLC Attorneys for Intel Corporation 50 Locust Avenue New Canaan, CT 06840

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Transmitted herewith for filing are:

- 1. ☑ Notice of Appeal
- 2.

 Pre-Appeal Brief Request for Review
- 3. ☑ Reason(s) for Requesting a Pre-Appeal Brief Review (5 pp)
- 4. ☑ Credit Card Payment via EFS-Web for \$500.00

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The Commissioner is hereby authorized to charge and credit Deposit Account No. <u>50-1852</u> as described below. A duplicate copy of this sheet is enclosed.

☑ Credit any overpayment.

☑ Charge any additional fees required under 37 CFR 1.16 and 1.17.

Respectfully submitted,

June 8, 2007
Date

/MS/

Mark Steinberg Registration No. 40,829 Buckley, Maschoff & Talwalkar LLC Attorneys for Intel Corporation 50 Locust Avenue New Canaan, CT 06840 (203) 972-0006, ext. 1014